

- Package Options Include Plastic "Small Outline" Packages, Ceramic Chip Carriers and Flat Packages, and Standard Plastic and Ceramic 300-mil DIPs
- Dependable Texas Instruments Quality and Reliability

TYPE	TYPICAL AVERAGE	TYPICAL
	PROPAGATION DELAY TIME	TOTAL POWER DISSIPATION
'86	14 ns	150 mW
'LS86A	10 ns	30.5 mW
'S86	7 ns	250 mW

### description

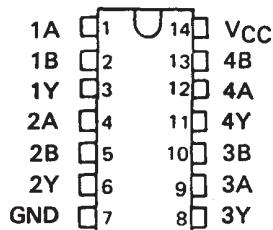
These devices contain four independent 2-input Exclusive-OR gates. They perform the Boolean functions  $Y = A \oplus B = \bar{A}B + A\bar{B}$  in positive logic.

A common application is as a true/complement element. If one of the inputs is low, the other input will be reproduced in true form at the output. If one of the inputs is high, the signal on the other input will be reproduced inverted at the output.

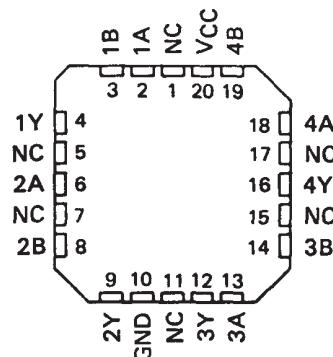
The SN5486, 54LS86A, and the SN54S86 are characterized for operation over the full military temperature range of  $-55^{\circ}\text{C}$  to  $125^{\circ}\text{C}$ . The SN7486, SN74LS86A, and the SN74S86 are characterized for operation from  $0^{\circ}\text{C}$  to  $70^{\circ}\text{C}$ .

SN5486, SN54LS86A, SN54S86 . . . J OR W PACKAGE  
 SN7486 . . . N PACKAGE  
 SN74LS86A, SN74S86 . . . D OR N PACKAGE

(TOP VIEW)



SN54LS86A, SN54S86 . . . FK PACKAGE  
 (TOP VIEW)



NC – No internal connection

### exclusive-OR logic

An exclusive-OR gate has many applications, some of which can be represented better by alternative logic symbols.

EXCLUSIVE-OR



These are five equivalent Exclusive-OR symbols valid for an '86 or 'LS86A gate in positive logic; negation may be shown at any two ports.

LOGIC IDENTITY ELEMENT



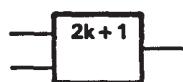
The output is active (low) if all inputs stand at the same logic level (i.e.,  $A=B$ ).

EVEN-PARITY



The output is active (low) if an even number of inputs (i.e., 0 or 2) are active.

ODD-PARITY ELEMENT



The output is active (high) if an odd number of inputs (i.e., only 1 of the 2) are active.

SN5486, SN54LS86A, SN54S86

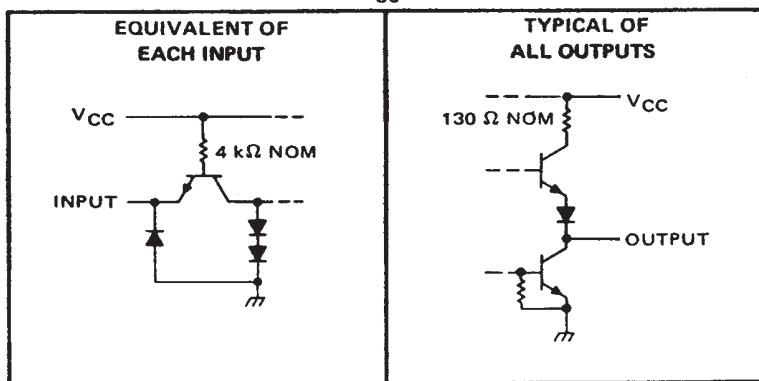
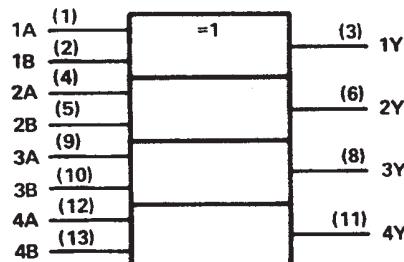
SN7486, SN74LS86A, SN74S86

**QUADRUPLE 2-INPUT EXCLUSIVE-OR GATES**

SDLS124 – DECEMBER 1972 – REVISED MARCH 1988

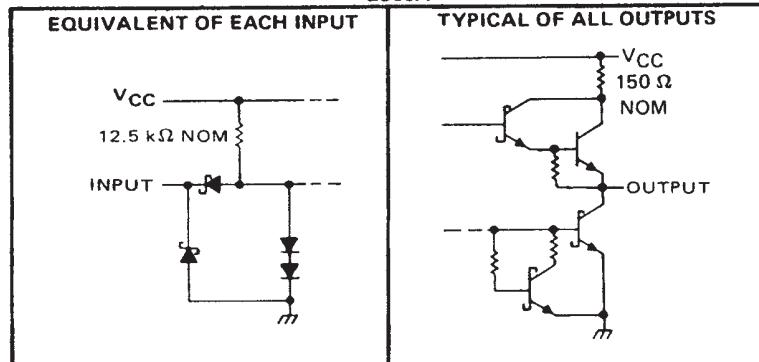
**schematics of inputs and outputs**

'86

**logic symbol†**

†This symbol is in accordance with  
ANSI/IEEE Std. 91-1984 and IEC Publication 617-12.  
Pin numbers shown are for D, J, N, and W packages.

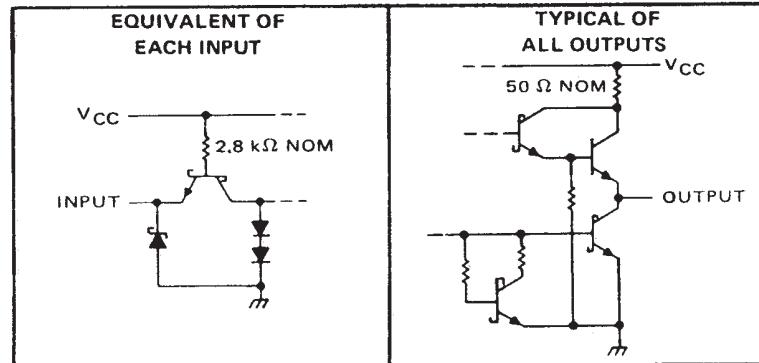
'LS86A

**FUNCTION TABLE**

INPUTS		OUTPUT
A	B	Y
L	L	L
L	H	H
H	L	H
H	H	L

H = high level, L = low level

'S86



**absolute maximum ratings over operating free-air temperature range (unless otherwise noted)**

NOTE 1: Voltage values are with respect to network ground terminal.

#### **recommended operating conditions**

	SN5486			SN7486			UNIT
	MIN	NOM	MAX	MIN	NOM	MAX	
Supply voltage, $V_{CC}$	4.5	5	5.5	4.75	5	5.25	V
High-level output current, $I_{OH}$			-800			-800	$\mu A$
Low-level output current, $I_{OL}$			16			16	mA
Operating free-air temperature, $T_A$	-55		125	0		70	$^{\circ}C$

**electrical characteristics over recommended operating free-air temperature range (unless otherwise noted)**

PARAMETER	TEST CONDITIONS <sup>†</sup>	SN5486			SN7486			UNIT
		MIN	TYP <sup>‡</sup>	MAX	MIN	TYP <sup>‡</sup>	MAX	
V <sub>IH</sub>	High-level input voltage			2		2		V
V <sub>IL</sub>	Low-level input voltage				0.8		0.8	V
V <sub>IK</sub>	Input clamp voltage	V <sub>CC</sub> = MIN, I <sub>I</sub> = -8 mA			-1.5		-1.5	V
V <sub>OH</sub>	High-level output voltage	V <sub>CC</sub> = MIN, V <sub>IH</sub> = 2 V, V <sub>IL</sub> = 0.8 V, I <sub>OH</sub> = -800 $\mu$ A	2.4	3.4		2.4	3.4	V
V <sub>OL</sub>	Low-level output voltage	V <sub>CC</sub> = MIN, V <sub>IH</sub> = 2 V V <sub>IL</sub> = 0.8 V, I <sub>OL</sub> = 16 mA		0.2	0.4		0.2	0.4
I <sub>I</sub>	Input current at maximum input voltage	V <sub>CC</sub> = MAX, V <sub>I</sub> = 5.5 V			1		1	mA
I <sub>IH</sub>	High-level input current	V <sub>CC</sub> = MAX, V <sub>I</sub> = 2.4 V			40		40	$\mu$ A
I <sub>IL</sub>	Low-level input current	V <sub>CC</sub> = MAX, V <sub>I</sub> = 0.4 V			-1.6		-1.6	mA
I <sub>OS</sub>	Short-circuit output current <sup>§</sup>	V <sub>CC</sub> = MAX	--20	-55	-18	-55		mA
I <sub>CC</sub>	Supply current	V <sub>CC</sub> = MAX, See Note 2		30	43		30	50

<sup>t</sup> For conditions shown as MIN or MAX, use the appropriate value specified under recommended operating conditions for the applicable type.

All typical values are at  $V_{CC} = 5$  V,  $T_A = 25^\circ\text{C}$ .

<sup>†</sup>All typical values are at  $V_{CC} = 5$  V,  $I_A = 25$  C.

NOTE 2:  $I_{OC}$  is measured with the inputs grounded and the outputs open.

NOTE 2:  $|V_{CC}|$  is measured with the inputs grounded and the outputs open.

switching characteristics,  $V_{CC} = 5 \text{ V}$ ,  $T_A = 25^\circ\text{C}$

PARAMETER <sup>1</sup>	FROM (INPUT)	TEST CONDITIONS			MIN	TYP	MAX	UNIT
t <sub>PLH</sub>	A or B	Other input low	C <sub>L</sub> = 15 pF, R <sub>L</sub> = 400 Ω,	See Note 3	15	23	ns	
t <sub>PHL</sub>					11	17		
t <sub>PLH</sub>	A or B	Other input high	C <sub>L</sub> = 15 pF, R <sub>L</sub> = 400 Ω,	See Note 3	18	30	ns	
t <sub>PHL</sub>					13	22		

$t_{\text{PPIH}}$  = propagation delay time, low-to-high-level output

tPHI = propagation delay time, high-to-low-level output

NOTE 3: Load circuits and voltage waveforms are shown in Section 1.

## OBSOLETE - No Longer Available

## **SN5486, SN54LS86A, SN54S86**

**SN7486, SN74LS86A, SN74S86**

## **QUADRUPLE 2-INPUT EXCLUSIVE-OR GATES**

SDLS124 – DECEMBER 1972 – REVISED MARCH 1988

**absolute maximum ratings over operating free-air temperature range (unless otherwise noted)**

NOTE 1: Voltage values are with respect to network ground terminal.

#### **recommended operating conditions**

	SN54LS86A			SN74LS86A			UNIT
	MIN	NOM	MAX	MIN	NOM	MAX	
Supply voltage, V <sub>CC</sub>	4.5	5	5.5	4.75	5	5.25	V
High-level output current, I <sub>OH</sub>			-400			-400	µA
Low-level output current, I <sub>OL</sub>			4			8	mA
Operating free-air temperature, T <sub>A</sub>	-55		125	0		70	°C

**electrical characteristics over recommended operating free-air temperature range (unless otherwise noted)**

PARAMETER	TEST CONDITIONS <sup>†</sup>	SN54LS86A			SN74LS86A			UNIT	
		MIN	TYP <sup>‡</sup>	MAX	MIN	TYP <sup>‡</sup>	MAX		
V <sub>IH</sub>	High-level input voltage			2		2		V	
V <sub>IL</sub>	Low-level input voltage				0.7		0.8	V	
V <sub>IK</sub>	Input clamp voltage	V <sub>CC</sub> = MIN,	I <sub>I</sub> = -18 mA		-1.5		-1.5	V	
V <sub>OH</sub>	High-level output voltage	V <sub>CC</sub> = MIN,	V <sub>IH</sub> = 2 V,		2.5	3.4	2.7	V	
		V <sub>IL</sub> = V <sub>IL</sub> max,	I <sub>OH</sub> = -400 $\mu$ A						
V <sub>OL</sub>	Low-level output voltage	V <sub>CC</sub> = MIN,	I <sub>OL</sub> = 4 mA		0.25	0.4	0.25	0.4	V
		V <sub>IH</sub> = 2 V,					0.35	0.5	
		V <sub>IL</sub> = V <sub>IL</sub> max	I <sub>OL</sub> = 8 mA						
I <sub>I</sub>	Input current at maximum input voltage	V <sub>CC</sub> = MAX,	V <sub>I</sub> = 7 V		0.2		0.2	mA	
I <sub>IH</sub>	High-level input current	V <sub>CC</sub> = MAX,	V <sub>I</sub> = 2.7 V		40		40	$\mu$ A	
I <sub>IL</sub>	Low-level input current	V <sub>CC</sub> = MAX,	V <sub>I</sub> = 0.4 V		-0.8		-0.8	mA	
I <sub>OS</sub>	Short-circuit output current <sup>§</sup>	V <sub>CC</sub> = MAX		-20	-100	-20	-100	mA	
I <sub>CC</sub>	Supply current	V <sub>CC</sub> = MAX,	See Note 2		6.1	10	6.1	10	mA

<sup>†</sup> For conditions shown as MIN or MAX, use the appropriate value specified under recommended operating conditions for the applicable type.

<sup>†</sup>All typical values are at  $V_{CC} = 5$  V,  $T_A = 25^\circ\text{C}$ .

<sup>†</sup>All typical values are at  $V_{CC} = 5\text{ V}$ ,  $T_A = 25^\circ\text{C}$ .  
<sup>§</sup>Not more than one output should be shorted at a time.

NOTE 2:  $I_{CC}$  is measured with the inputs grounded and the outputs open.

NOTE 2:  $I_{CC}$  is measured with the inputs grounded and the outputs open.

switching characteristics,  $V_{CC} = 5 \text{ V}$ ,  $T_A = 25^\circ\text{C}$

PARAMETER <sup>1</sup>	FROM (INPUT)	TEST CONDITIONS		MIN	TYP	MAX	UNIT	
t <sub>PLH</sub>	A or B	Other input low	C <sub>L</sub> = 15 pF, R <sub>L</sub> = 2 kΩ, See Note 3	12	23		ns	
t <sub>PHL</sub>				10	17			
t <sub>PLH</sub>		Other input high		20	30		ns	
t <sub>PHL</sub>				13	22			

$t_{PLH}$  = propagation delay time, low-to-high-level output

**tpHL** = propagation delay time, high-to-low-level output

**NOTE 3:** Load circuits and voltage waveforms are shown in Section 1.

**absolute maximum ratings over operating free-air temperature range (unless otherwise noted)**

NOTE 1: Voltage values are with respect to network ground terminal.

#### **recommended operating conditions**

	SN54S86			SN74S86			UNIT
	MIN	NOM	MAX	MIN	NOM	MAX	
Supply voltage, V <sub>CC</sub>	4.5	5	5.5	4.75	5	5.25	V
High-level output current, I <sub>OH</sub>			-1			-1	mA
Low-level output current, I <sub>OL</sub>			20			20	mA
Operating free-air temperature, T <sub>A</sub>	-55		125	0		70	°C

**electrical characteristics over recommended operating free-air temperature range (unless otherwise noted)**

PARAMETER	TEST CONDITIONS <sup>†</sup>	SN54S86			SN74S86			UNIT
		MIN	TYP <sup>‡</sup>	MAX	MIN	TYP <sup>‡</sup>	MAX	
V <sub>IH</sub>	High-level input voltage			2		2		V
V <sub>IL</sub>	Low-level input voltage				0.8		0.8	V
V <sub>IK</sub>	Input clamp voltage	V <sub>CC</sub> = MIN, I <sub>I</sub> = -18 mA			-1.2		-1.2	V
V <sub>OH</sub>	High-level output voltage	V <sub>CC</sub> = MIN, V <sub>IH</sub> = 2 V, V <sub>IL</sub> = 0.8 V, I <sub>OH</sub> = -1 mA	2.5	3.4		2.7	3.4	V
V <sub>OL</sub>	Low-level output voltage	V <sub>CC</sub> = MIN, V <sub>IH</sub> = 2 V V <sub>IL</sub> = 0.8 V, I <sub>OL</sub> = 20 mA			0.5		0.5	V
I <sub>I</sub>	Input current at maximum input voltage	V <sub>CC</sub> = MAX, V <sub>I</sub> = 5.5 V		1		1		mA
I <sub>IH</sub>	High-level input current	V <sub>CC</sub> = MAX, V <sub>I</sub> = 2.7 V		50		50		μA
I <sub>IL</sub>	Low-level input current	V <sub>CC</sub> = MAX, V <sub>I</sub> = 0.5 V		-2		-2		mA
I <sub>OS</sub>	Short-circuit output current <sup>§</sup>	V <sub>CC</sub> = MAX	-40	-100	-40	-100		mA
I <sub>CC</sub>	Supply current	V <sub>CC</sub> = MAX, See Note 2	50	75	50	75		mA

<sup>†</sup> For conditions shown as MIN or MAX, use the appropriate value specified under recommended operating conditions for the applicable type.

<sup>‡</sup>All typical values are at  $V_{CC} = 5$  V,  $T_A = 25^\circ\text{C}$ .

~~Not more than one output should be shorted at a time, and duration of the short-circuit should not exceed one second.~~

**NOTE 3:**  $I_{OC}$  is measured with the inputs grounded and the outputs open.

switching characteristics,  $V_{CC} = 5$  V,  $T_A = 25^\circ\text{C}$

PARAMETER <sup>1</sup>	FROM (INPUT)	TEST CONDITIONS		MIN	TYP	MAX	UNIT
t <sub>PLH</sub>	A or B	Other input low	C <sub>L</sub> = 15 pF, R <sub>L</sub> = 280 Ω, See Note 3	7	10.5	ns	
t <sub>PHL</sub>				6.5	10		
t <sub>PLH</sub>	A or B	Other input high	See Note 3	7	10.5	ns	
t <sub>PHL</sub>				6.5	10		

$t_{\text{tpi}} H$  = propagation delay time, low-to-high-level output

**tPHL** = propagation delay time, high-to-low-level output

**NOTE 3:** Load circuits and voltage waveforms are shown in Section 1.

**PACKAGING INFORMATION**

Orderable Device	Status (1)	Package Type	Package Drawing	Pins	Package Qty	Eco Plan (2)	Lead finish/ Ball material (6)	MSL Peak Temp (3)	Op Temp (°C)	Device Marking (4/5)	Samples
JM38510/07501BCA	ACTIVE	CDIP	J	14	25	Non-RoHS & Green	SNPB	N / A for Pkg Type	-55 to 125	JM38510/07501BCA	Samples
JM38510/07501BDA	ACTIVE	CFP	W	14	25	Non-RoHS & Green	SNPB	N / A for Pkg Type	-55 to 125	JM38510/07501BDA	Samples
JM38510/07501BDA	ACTIVE	CFP	W	14	25	Non-RoHS & Green	SNPB	N / A for Pkg Type	-55 to 125	JM38510/07501BDA	Samples
JM38510/30502B2A	ACTIVE	LCCC	FK	20	55	Non-RoHS & Green	SNPB	N / A for Pkg Type	-55 to 125	JM38510/30502B2A	Samples
JM38510/30502B2A	ACTIVE	LCCC	FK	20	55	Non-RoHS & Green	SNPB	N / A for Pkg Type	-55 to 125	JM38510/30502B2A	Samples
JM38510/30502BCA	ACTIVE	CDIP	J	14	25	Non-RoHS & Green	SNPB	N / A for Pkg Type	-55 to 125	JM38510/30502BCA	Samples
JM38510/30502BCA	ACTIVE	CDIP	J	14	25	Non-RoHS & Green	SNPB	N / A for Pkg Type	-55 to 125	JM38510/30502BCA	Samples
JM38510/30502BDA	ACTIVE	CFP	W	14	25	Non-RoHS & Green	SNPB	N / A for Pkg Type	-55 to 125	JM38510/30502BDA	Samples
JM38510/30502BDA	ACTIVE	CFP	W	14	25	Non-RoHS & Green	SNPB	N / A for Pkg Type	-55 to 125	JM38510/30502BDA	Samples
M38510/07501BCA	ACTIVE	CDIP	J	14	25	Non-RoHS & Green	SNPB	N / A for Pkg Type	-55 to 125	JM38510/07501BCA	Samples
M38510/07501BCA	ACTIVE	CDIP	J	14	25	Non-RoHS & Green	SNPB	N / A for Pkg Type	-55 to 125	JM38510/07501BCA	Samples
M38510/07501BDA	ACTIVE	CFP	W	14	25	Non-RoHS & Green	SNPB	N / A for Pkg Type	-55 to 125	JM38510/07501BDA	Samples
M38510/07501BDA	ACTIVE	CFP	W	14	25	Non-RoHS & Green	SNPB	N / A for Pkg Type	-55 to 125	JM38510/07501BDA	Samples
M38510/30502B2A	ACTIVE	LCCC	FK	20	55	Non-RoHS & Green	SNPB	N / A for Pkg Type	-55 to 125	JM38510/30502B2A	Samples
M38510/30502B2A	ACTIVE	LCCC	FK	20	55	Non-RoHS & Green	SNPB	N / A for Pkg Type	-55 to 125	JM38510/30502B2A	Samples
M38510/30502BCA	ACTIVE	CDIP	J	14	25	Non-RoHS & Green	SNPB	N / A for Pkg Type	-55 to 125	JM38510/30502BCA	Samples

Orderable Device	Status (1)	Package Type	Package Drawing	Pins	Package Qty	Eco Plan (2)	Lead finish/ Ball material (6)	MSL Peak Temp (3)	Op Temp (°C)	Device Marking (4/5)	Samples
M38510/30502BCA	ACTIVE	CDIP	J	14	25	Non-RoHS & Green	SNPB	N / A for Pkg Type	-55 to 125	JM38510/30502BCA	Samples
M38510/30502BDA	ACTIVE	CFP	W	14	25	Non-RoHS & Green	SNPB	N / A for Pkg Type	-55 to 125	JM38510/30502BDA	Samples
M38510/30502BDA	ACTIVE	CFP	W	14	25	Non-RoHS & Green	SNPB	N / A for Pkg Type	-55 to 125	JM38510/30502BDA	Samples
SN54LS86AJ	ACTIVE	CDIP	J	14	25	Non-RoHS & Green	SNPB	N / A for Pkg Type	-55 to 125	SN54LS86AJ	Samples
SN54LS86AJ	ACTIVE	CDIP	J	14	25	Non-RoHS & Green	SNPB	N / A for Pkg Type	-55 to 125	SN54LS86AJ	Samples
SN54S86J	ACTIVE	CDIP	J	14	25	Non-RoHS & Green	SNPB	N / A for Pkg Type	-55 to 125	SN54S86J	Samples
SN54S86J	ACTIVE	CDIP	J	14	25	Non-RoHS & Green	SNPB	N / A for Pkg Type	-55 to 125	SN54S86J	Samples
SN74LS86ADR	ACTIVE	SOIC	D	14	2500	RoHS & Green	NIPDAU	Level-1-260C-UNLIM	0 to 70	LS86A	Samples
SN74LS86ADR	ACTIVE	SOIC	D	14	2500	RoHS & Green	NIPDAU	Level-1-260C-UNLIM	0 to 70	LS86A	Samples
SN74LS86ADRE4	ACTIVE	SOIC	D	14	2500	RoHS & Green	NIPDAU	Level-1-260C-UNLIM	0 to 70	LS86A	Samples
SN74LS86ADRE4	ACTIVE	SOIC	D	14	2500	RoHS & Green	NIPDAU	Level-1-260C-UNLIM	0 to 70	LS86A	Samples
SN74LS86AN	ACTIVE	PDIP	N	14	25	RoHS & Green	NIPDAU	N / A for Pkg Type	0 to 70	SN74LS86AN	Samples
SN74LS86AN	ACTIVE	PDIP	N	14	25	RoHS & Green	NIPDAU	N / A for Pkg Type	0 to 70	SN74LS86AN	Samples
SN74LS86ANE4	ACTIVE	PDIP	N	14	25	RoHS & Green	NIPDAU	N / A for Pkg Type	0 to 70	SN74LS86AN	Samples
SN74LS86ANE4	ACTIVE	PDIP	N	14	25	RoHS & Green	NIPDAU	N / A for Pkg Type	0 to 70	SN74LS86AN	Samples
SN74LS86ANSR	ACTIVE	SO	NS	14	2000	RoHS & Green	NIPDAU	Level-1-260C-UNLIM	0 to 70	74LS86A	Samples
SN74LS86ANSR	ACTIVE	SO	NS	14	2000	RoHS & Green	NIPDAU	Level-1-260C-UNLIM	0 to 70	74LS86A	Samples
SNJ54LS86AFK	ACTIVE	LCCC	FK	20	55	Non-RoHS & Green	SNPB	N / A for Pkg Type	-55 to 125	SNJ54LS86AFK	Samples
SNJ54LS86AFK	ACTIVE	LCCC	FK	20	55	Non-RoHS & Green	SNPB	N / A for Pkg Type	-55 to 125	SNJ54LS86AFK	Samples

Orderable Device	Status (1)	Package Type	Package Drawing	Pins	Package Qty	Eco Plan (2)	Lead finish/ Ball material (6)	MSL Peak Temp (3)	Op Temp (°C)	Device Marking (4/5)	Samples
SNJ54LS86AJ	ACTIVE	CDIP	J	14	25	Non-RoHS & Green	SNPB	N / A for Pkg Type	-55 to 125	SNJ54LS86AJ	Samples
SNJ54LS86AJ	ACTIVE	CDIP	J	14	25	Non-RoHS & Green	SNPB	N / A for Pkg Type	-55 to 125	SNJ54LS86AJ	Samples
SNJ54LS86AW	ACTIVE	CFP	W	14	25	Non-RoHS & Green	SNPB	N / A for Pkg Type	-55 to 125	SNJ54LS86AW	Samples
SNJ54LS86AW	ACTIVE	CFP	W	14	25	Non-RoHS & Green	SNPB	N / A for Pkg Type	-55 to 125	SNJ54LS86AW	Samples
SNJ54S86J	ACTIVE	CDIP	J	14	25	Non-RoHS & Green	SNPB	N / A for Pkg Type	-55 to 125	SNJ54S86J	Samples
SNJ54S86J	ACTIVE	CDIP	J	14	25	Non-RoHS & Green	SNPB	N / A for Pkg Type	-55 to 125	SNJ54S86J	Samples

(1) The marketing status values are defined as follows:

**ACTIVE:** Product device recommended for new designs.

**LIFEBUY:** TI has announced that the device will be discontinued, and a lifetime-buy period is in effect.

**NRND:** Not recommended for new designs. Device is in production to support existing customers, but TI does not recommend using this part in a new design.

**PREVIEW:** Device has been announced but is not in production. Samples may or may not be available.

**OBsolete:** TI has discontinued the production of the device.

(2) **RoHS:** TI defines "RoHS" to mean semiconductor products that are compliant with the current EU RoHS requirements for all 10 RoHS substances, including the requirement that RoHS substance do not exceed 0.1% by weight in homogeneous materials. Where designed to be soldered at high temperatures, "RoHS" products are suitable for use in specified lead-free processes. TI may reference these types of products as "Pb-Free".

**RoHS Exempt:** TI defines "RoHS Exempt" to mean products that contain lead but are compliant with EU RoHS pursuant to a specific EU RoHS exemption.

**Green:** TI defines "Green" to mean the content of Chlorine (Cl) and Bromine (Br) based flame retardants meet JS709B low halogen requirements of <=1000ppm threshold. Antimony trioxide based flame retardants must also meet the <=1000ppm threshold requirement.

(3) MSL, Peak Temp. - The Moisture Sensitivity Level rating according to the JEDEC industry standard classifications, and peak solder temperature.

(4) There may be additional marking, which relates to the logo, the lot trace code information, or the environmental category on the device.

(5) Multiple Device Markings will be inside parentheses. Only one Device Marking contained in parentheses and separated by a "~" will appear on a device. If a line is indented then it is a continuation of the previous line and the two combined represent the entire Device Marking for that device.

(6) Lead finish/Ball material - Orderable Devices may have multiple material finish options. Finish options are separated by a vertical ruled line. Lead finish/Ball material values may wrap to two lines if the finish value exceeds the maximum column width.

**Important Information and Disclaimer:** The information provided on this page represents TI's knowledge and belief as of the date that it is provided. TI bases its knowledge and belief on information provided by third parties, and makes no representation or warranty as to the accuracy of such information. Efforts are underway to better integrate information from third parties. TI has taken and continues to take reasonable steps to provide representative and accurate information but may not have conducted destructive testing or chemical analysis on incoming materials and chemicals. TI and TI suppliers consider certain information to be proprietary, and thus CAS numbers and other limited information may not be available for release.

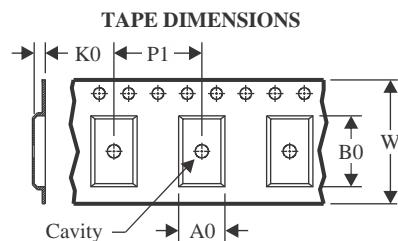
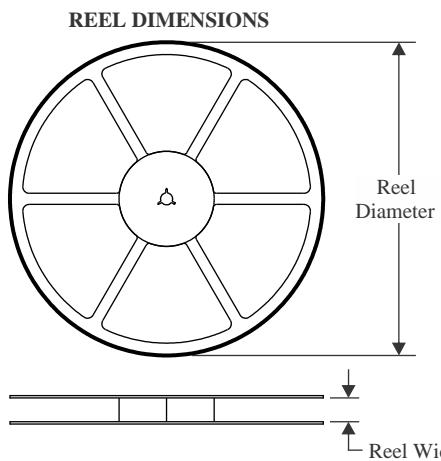
In no event shall TI's liability arising out of such information exceed the total purchase price of the TI part(s) at issue in this document sold by TI to Customer on an annual basis.

**OTHER QUALIFIED VERSIONS OF SN54LS86A, SN74LS86A :**

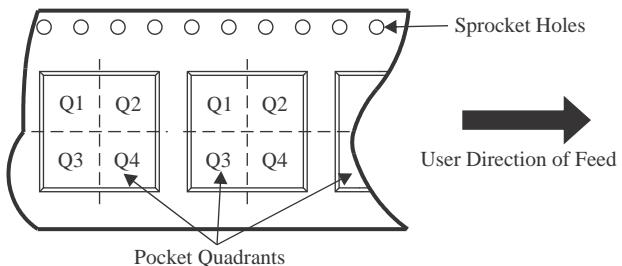
- Catalog : [SN74LS86A](#)
- Military : [SN54LS86A](#)

NOTE: Qualified Version Definitions:

- Catalog - TI's standard catalog product
- Military - QML certified for Military and Defense Applications

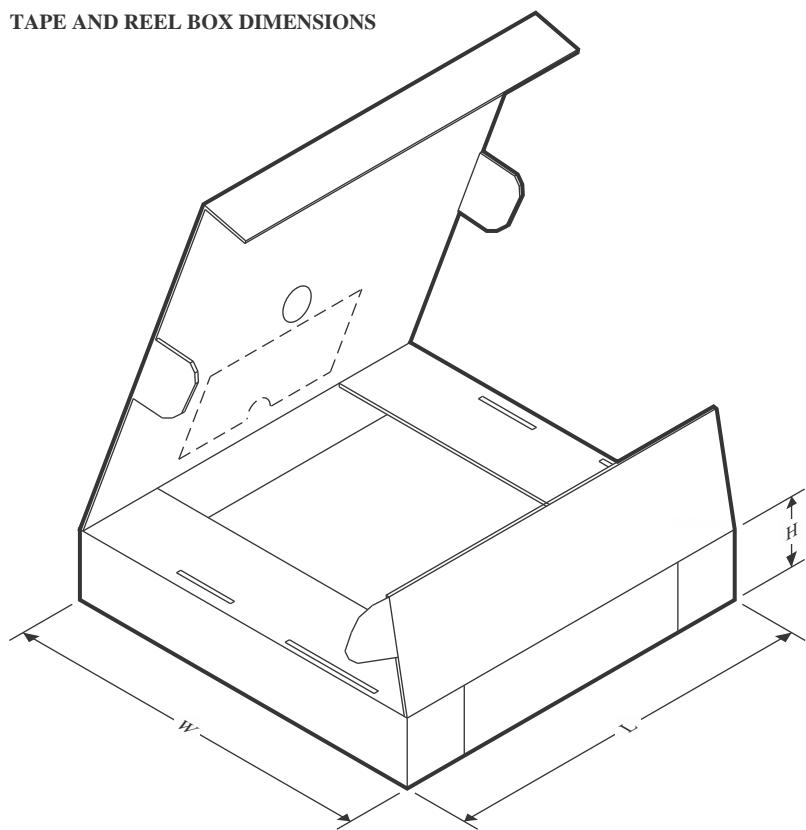
**TAPE AND REEL INFORMATION**


A0	Dimension designed to accommodate the component width
B0	Dimension designed to accommodate the component length
K0	Dimension designed to accommodate the component thickness
W	Overall width of the carrier tape
P1	Pitch between successive cavity centers

**QUADRANT ASSIGNMENTS FOR PIN 1 ORIENTATION IN TAPE**


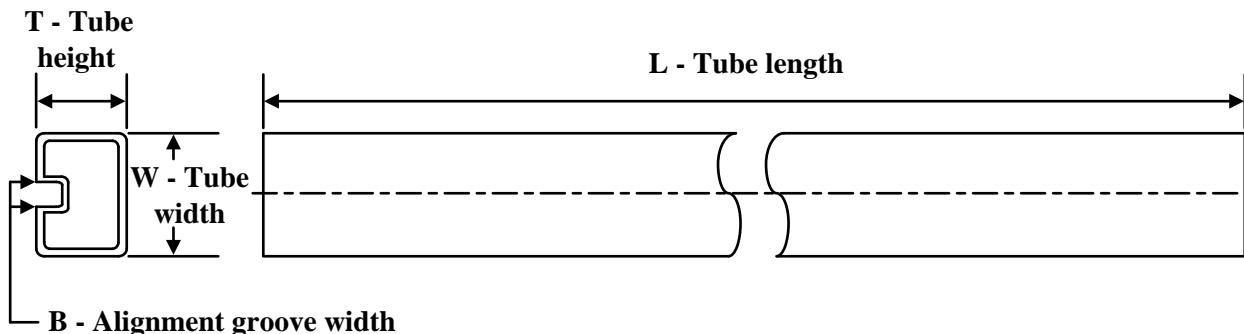
\*All dimensions are nominal

Device	Package Type	Package Drawing	Pins	SPQ	Reel Diameter (mm)	Reel Width W1 (mm)	A0 (mm)	B0 (mm)	K0 (mm)	P1 (mm)	W (mm)	Pin1 Quadrant
SN74LS86ADR	SOIC	D	14	2500	330.0	16.4	6.5	9.0	2.1	8.0	16.0	Q1
SN74LS86ANSR	SO	NS	14	2000	330.0	16.4	8.2	10.5	2.5	12.0	16.0	Q1

**TAPE AND REEL BOX DIMENSIONS**


\*All dimensions are nominal

Device	Package Type	Package Drawing	Pins	SPQ	Length (mm)	Width (mm)	Height (mm)
SN74LS86ADR	SOIC	D	14	2500	356.0	356.0	35.0
SN74LS86ANSR	SO	NS	14	2000	356.0	356.0	35.0

**TUBE**


\*All dimensions are nominal

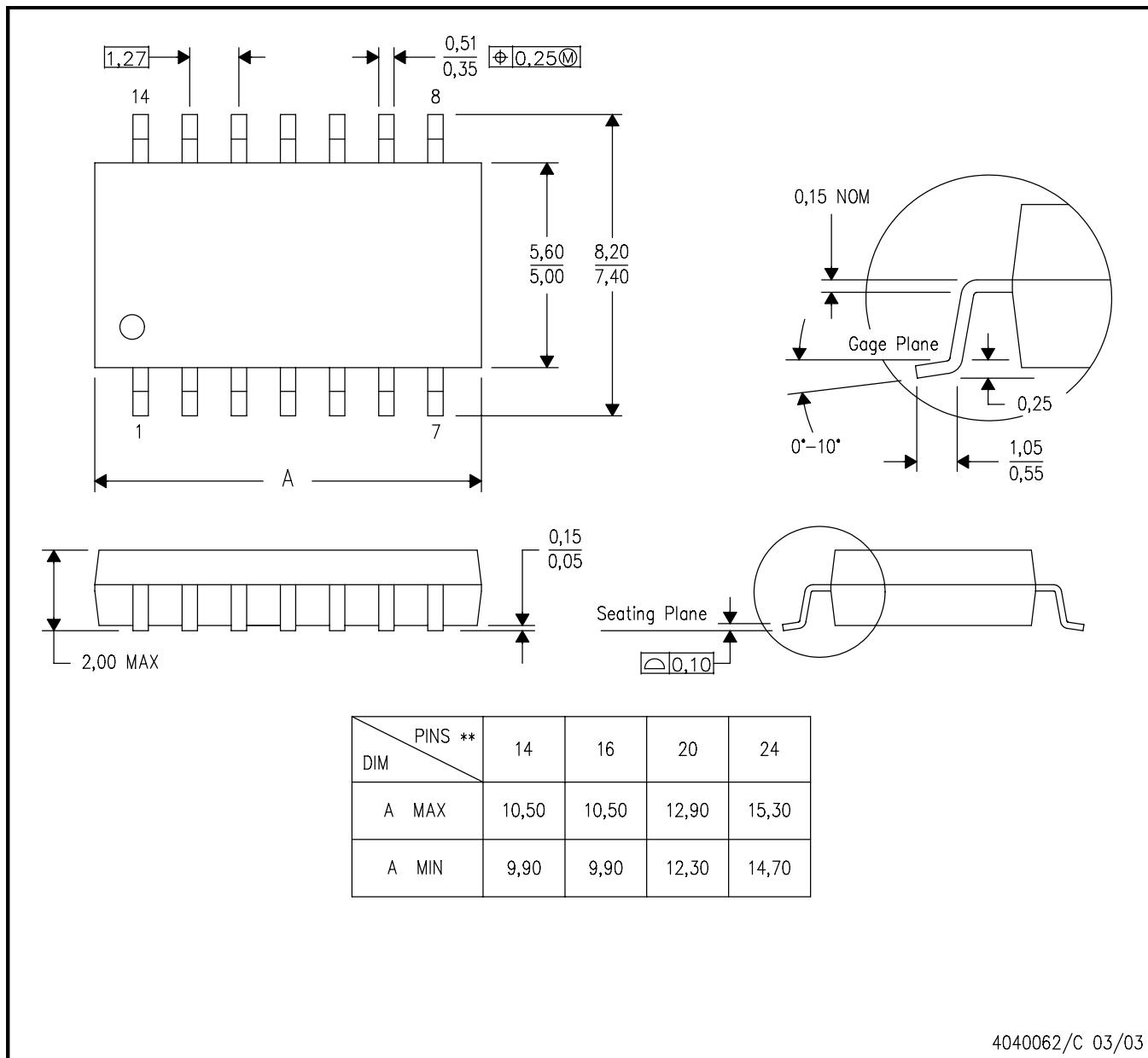
Device	Package Name	Package Type	Pins	SPQ	L (mm)	W (mm)	T ( $\mu$ m)	B (mm)
JM38510/07501BDA	W	CFP	14	25	506.98	26.16	6220	NA
JM38510/30502B2A	FK	LCCC	20	55	506.98	12.06	2030	NA
JM38510/30502BDA	W	CFP	14	25	506.98	26.16	6220	NA
M38510/07501BDA	W	CFP	14	25	506.98	26.16	6220	NA
M38510/30502B2A	FK	LCCC	20	55	506.98	12.06	2030	NA
M38510/30502BDA	W	CFP	14	25	506.98	26.16	6220	NA
SN74LS86AN	N	PDIP	14	25	506	13.97	11230	4.32
SN74LS86AN	N	PDIP	14	25	506	13.97	11230	4.32
SN74LS86ANE4	N	PDIP	14	25	506	13.97	11230	4.32
SN74LS86ANE4	N	PDIP	14	25	506	13.97	11230	4.32
SNJ54LS86AFK	FK	LCCC	20	55	506.98	12.06	2030	NA
SNJ54LS86AW	W	CFP	14	25	506.98	26.16	6220	NA

## MECHANICAL DATA

**NS (R-PDSO-G\*\*)**

**14-PINS SHOWN**

**PLASTIC SMALL-OUTLINE PACKAGE**

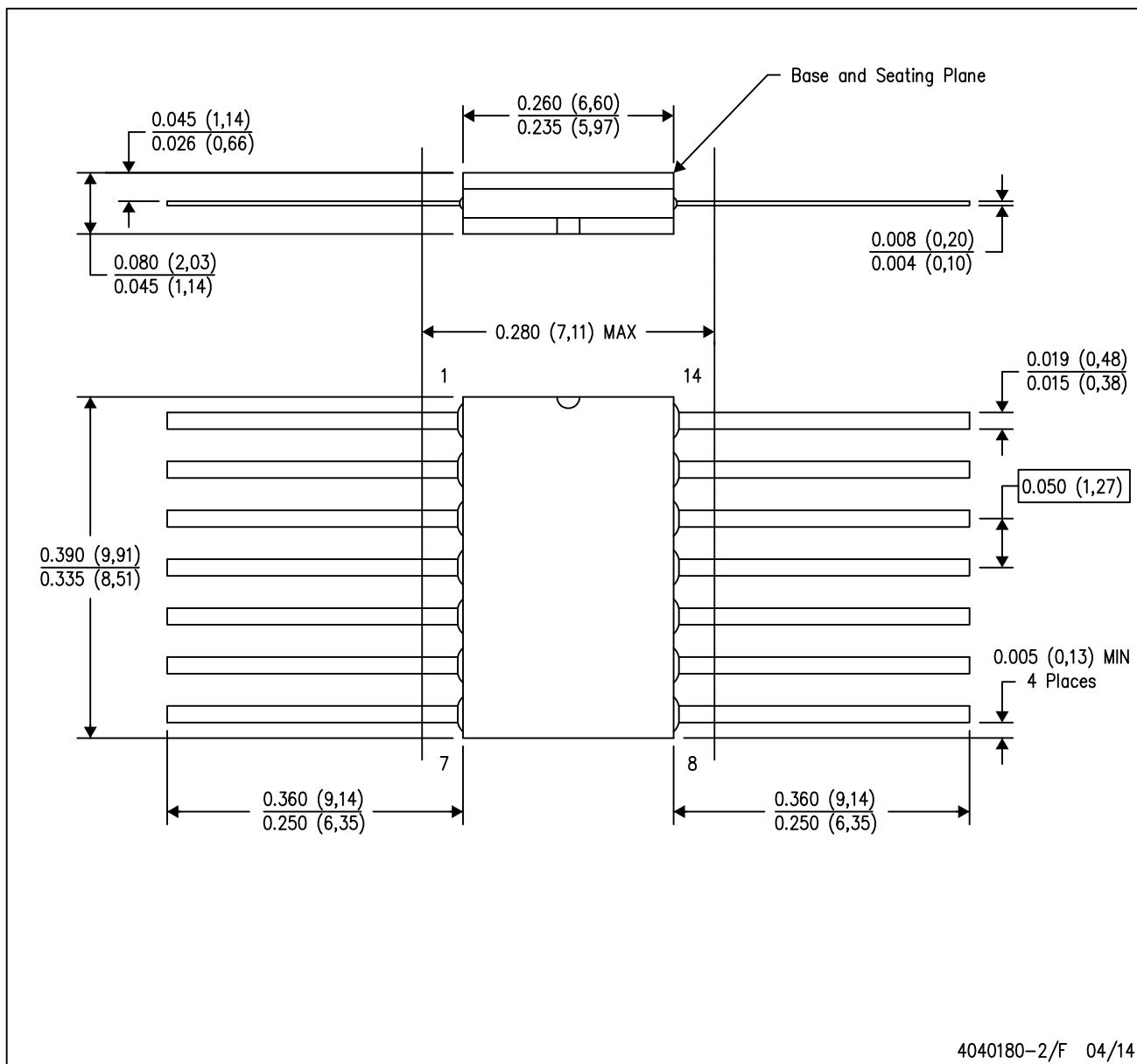


- NOTES: A. All linear dimensions are in millimeters.  
 B. This drawing is subject to change without notice.  
 C. Body dimensions do not include mold flash or protrusion, not to exceed 0,15.

## MECHANICAL DATA

W (R-GDFP-F14)

CERAMIC DUAL FLATPACK



- NOTES:
- A. All linear dimensions are in inches (millimeters).
  - B. This drawing is subject to change without notice.
  - C. This package can be hermetically sealed with a ceramic lid using glass frit.
  - D. Index point is provided on cap for terminal identification only.
  - E. Falls within MIL STD 1835 GDFP1-F14

# GENERIC PACKAGE VIEW

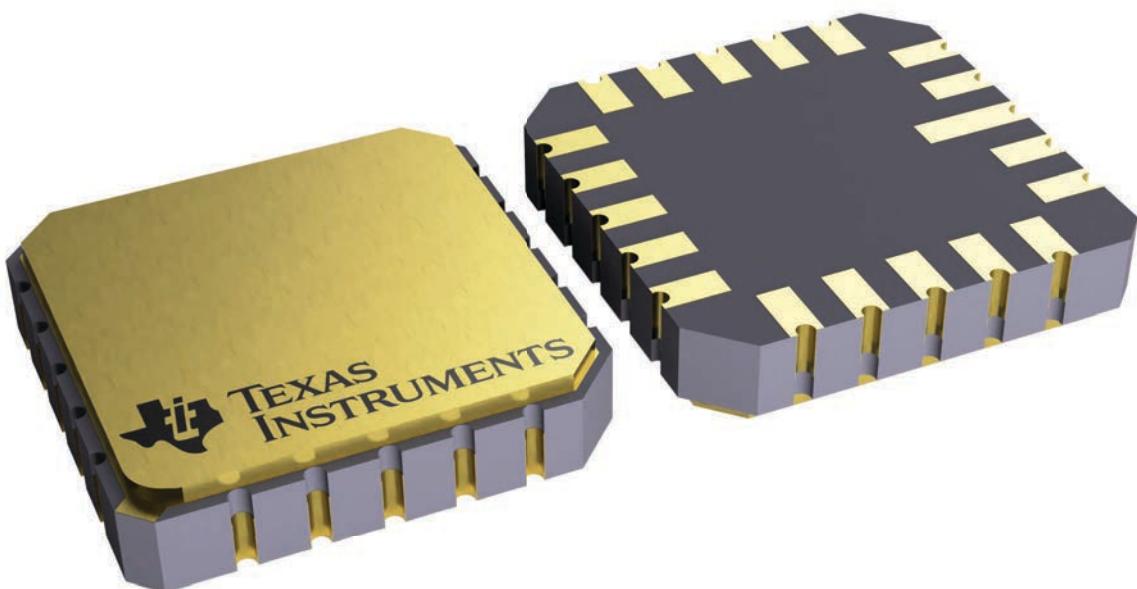
**FK 20**

**LCCC - 2.03 mm max height**

**8.89 x 8.89, 1.27 mm pitch**

**LEADLESS CERAMIC CHIP CARRIER**

This image is a representation of the package family, actual package may vary.  
Refer to the product data sheet for package details.



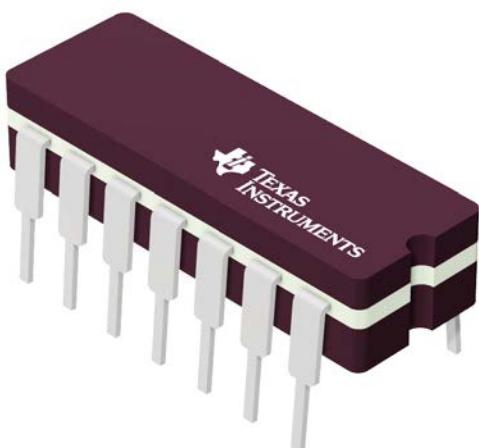
4229370VA\

# GENERIC PACKAGE VIEW

J 14

**CDIP - 5.08 mm max height**

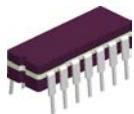
CERAMIC DUAL IN LINE PACKAGE



Images above are just a representation of the package family, actual package may vary.  
Refer to the product data sheet for package details.

4040083-5/G

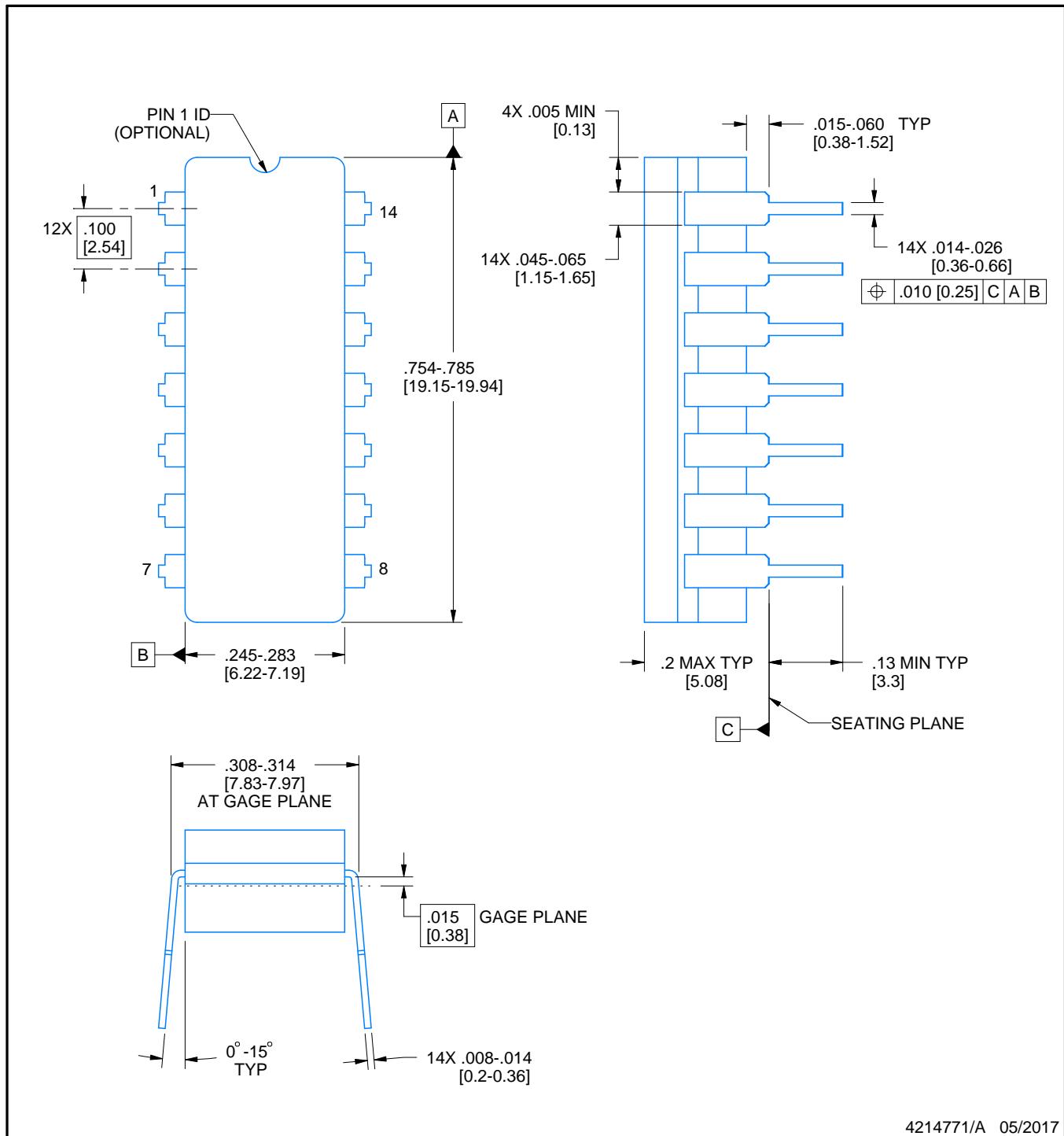
J0014A



# PACKAGE OUTLINE

## CDIP - 5.08 mm max height

CERAMIC DUAL IN LINE PACKAGE



4214771/A 05/2017

### NOTES:

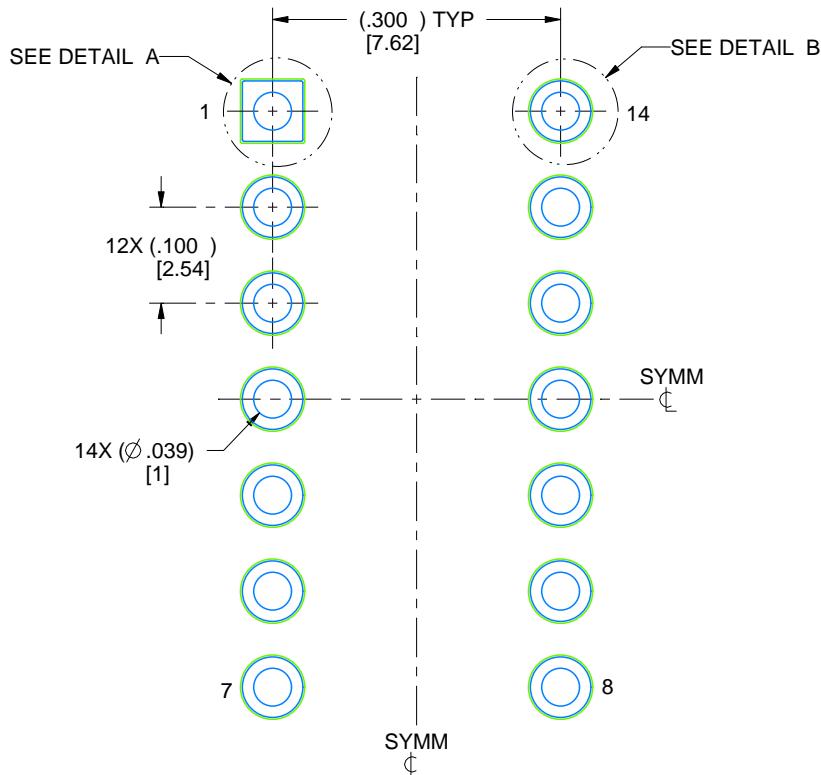
- All controlling linear dimensions are in inches. Dimensions in brackets are in millimeters. Any dimension in brackets or parenthesis are for reference only. Dimensioning and tolerancing per ASME Y14.5M.
- This drawing is subject to change without notice.
- This package is hermetically sealed with a ceramic lid using glass frit.
- Index point is provided on cap for terminal identification only and on press ceramic glass frit seal only.
- Falls within MIL-STD-1835 and GDIP1-T14.

# EXAMPLE BOARD LAYOUT

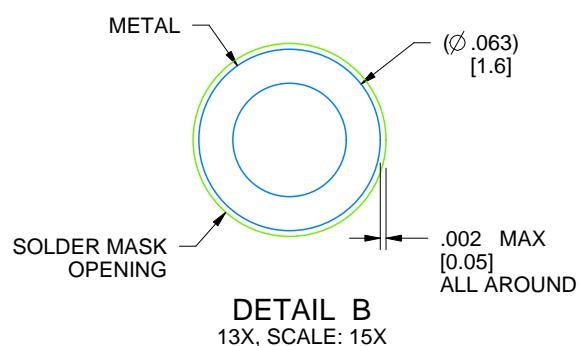
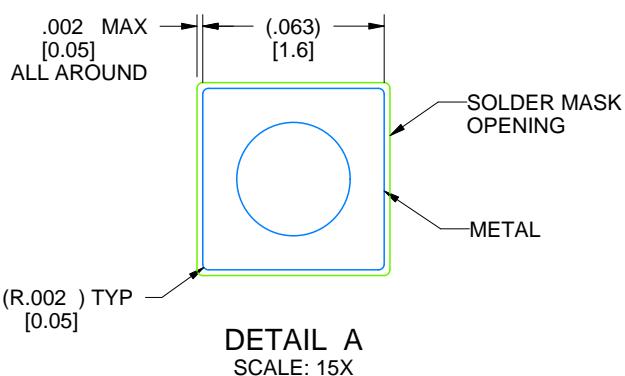
J0014A

CDIP - 5.08 mm max height

CERAMIC DUAL IN LINE PACKAGE



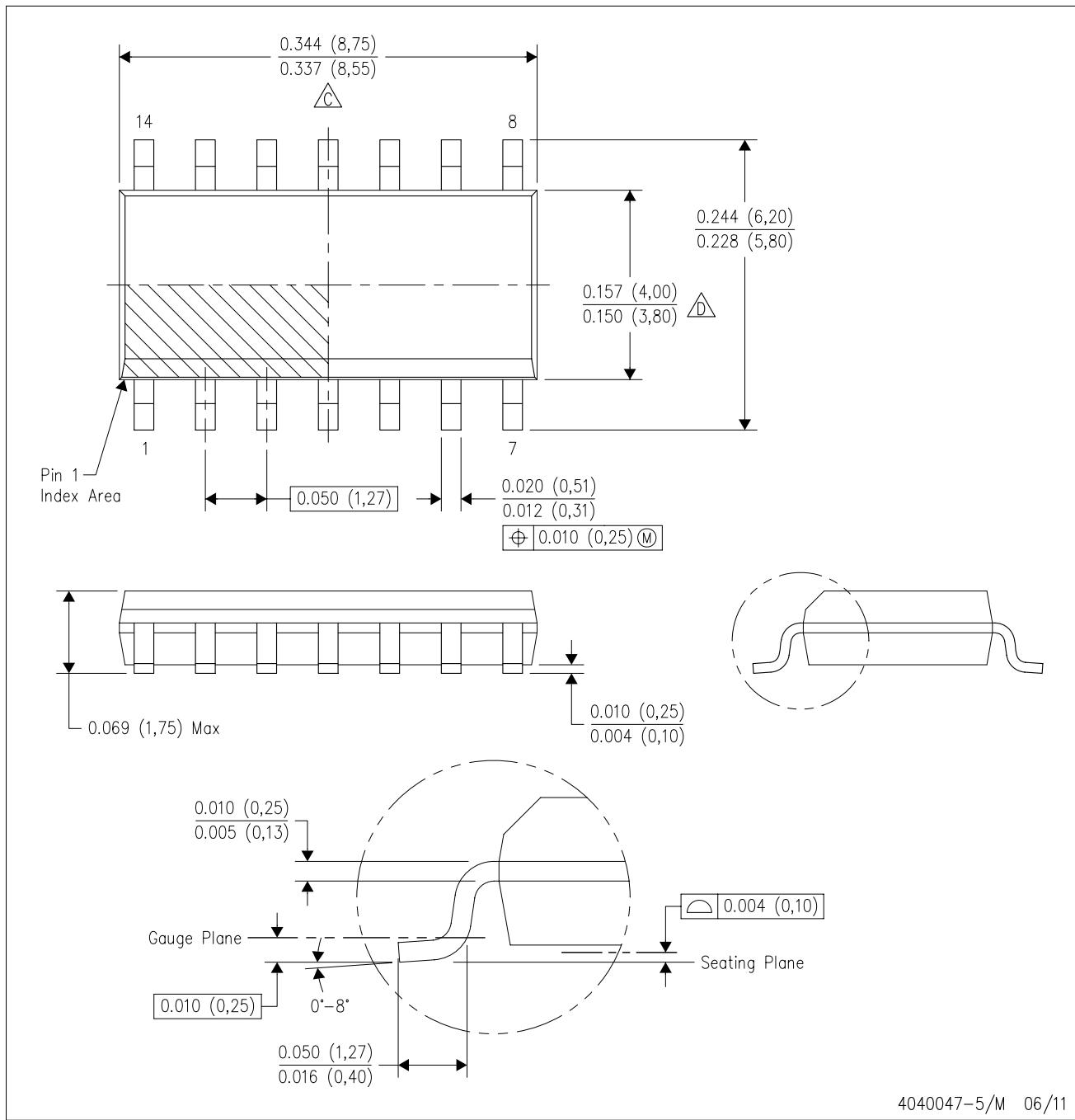
LAND PATTERN EXAMPLE  
NON-SOLDER MASK DEFINED  
SCALE: 5X



4214771/A 05/2017

D (R-PDSO-G14)

PLASTIC SMALL OUTLINE



NOTES: A. All linear dimensions are in inches (millimeters).

B. This drawing is subject to change without notice.

C Body length does not include mold flash, protrusions, or gate burrs. Mold flash, protrusions, or gate burrs shall not exceed 0.006 (0,15) each side.

D Body width does not include interlead flash. Interlead flash shall not exceed 0.017 (0,43) each side.

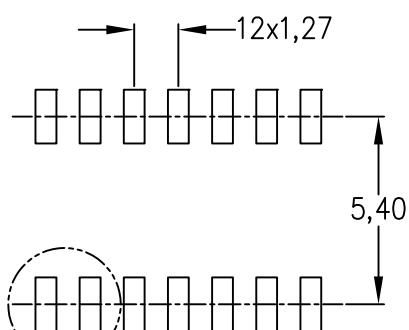
E. Reference JEDEC MS-012 variation AB.

## LAND PATTERN DATA

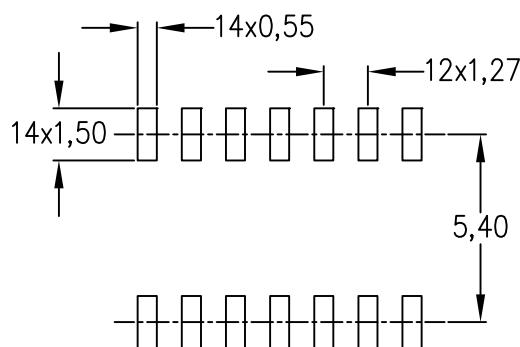
D (R-PDSO-G14)

PLASTIC SMALL OUTLINE

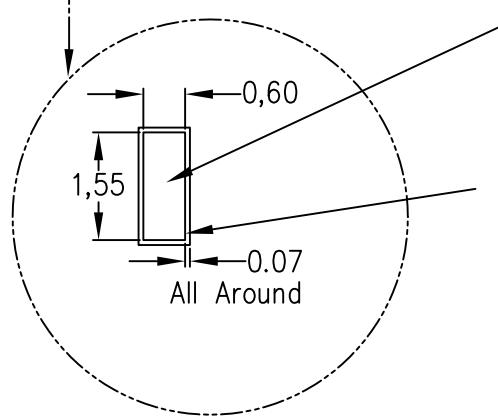
Example Board Layout  
(Note C)



Stencil Openings  
(Note D)



Example  
Non Soldermask Defined Pad



Example  
Pad Geometry  
(See Note C)

Example  
Solder Mask Opening  
(See Note E)

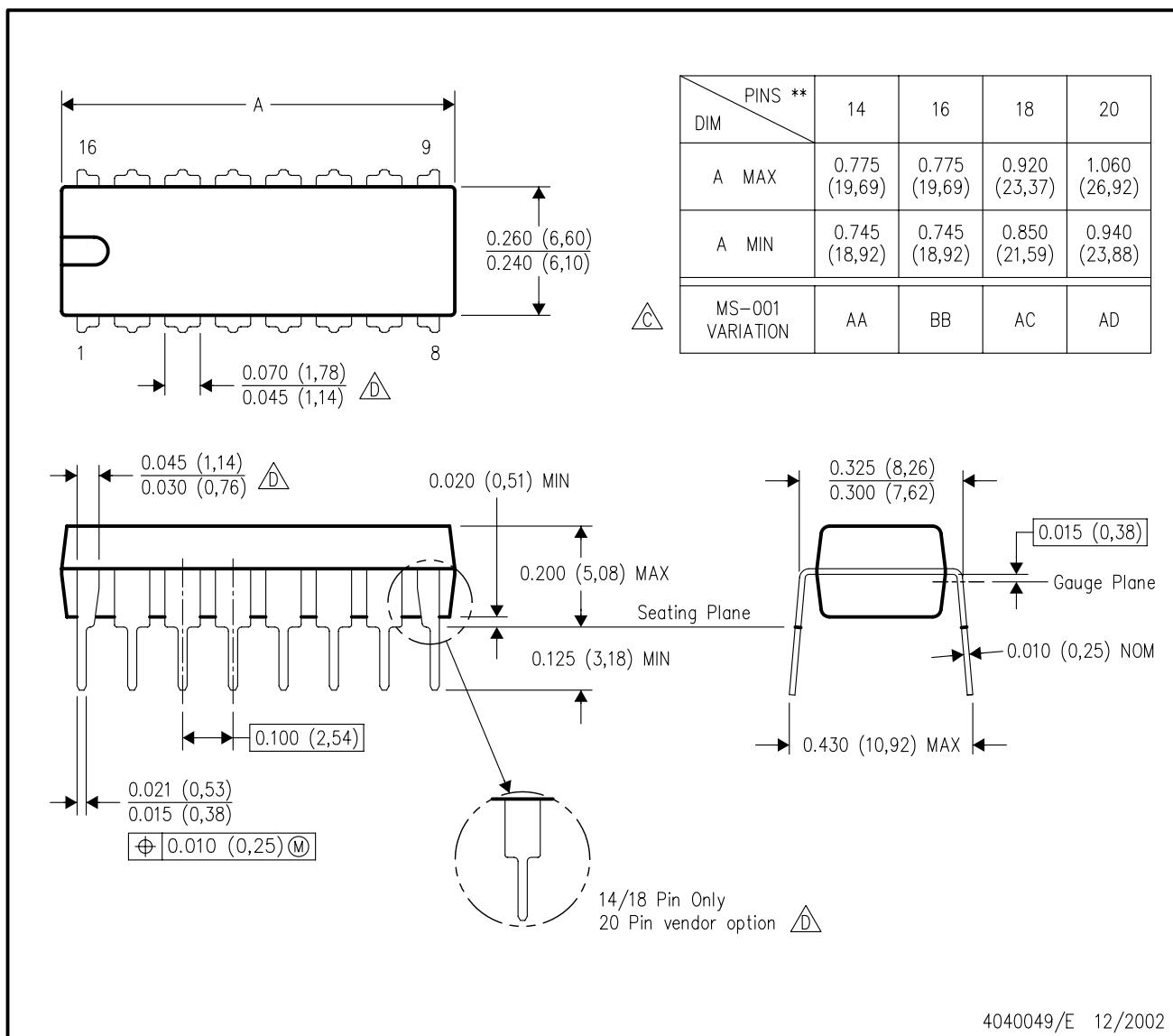
4211283-3/E 08/12

- NOTES:
- A. All linear dimensions are in millimeters.
  - B. This drawing is subject to change without notice.
  - C. Publication IPC-7351 is recommended for alternate designs.
  - D. Laser cutting apertures with trapezoidal walls and also rounding corners will offer better paste release. Customers should contact their board assembly site for stencil design recommendations. Refer to IPC-7525 for other stencil recommendations.
  - E. Customers should contact their board fabrication site for solder mask tolerances between and around signal pads.

## N (R-PDIP-T\*\*)

16 PINS SHOWN

## PLASTIC DUAL-IN-LINE PACKAGE



NOTES: A. All linear dimensions are in inches (millimeters).  
B. This drawing is subject to change without notice.

Symbol C: Falls within JEDEC MS-001, except 18 and 20 pin minimum body length (Dim A).

Symbol D: The 20 pin end lead shoulder width is a vendor option, either half or full width.

4040049/E 12/2002

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